

### **NPN Silicon RF Transistor\***

- For low noise, low distortion broadband amplifiers in antenna and telecommunication systems up to 1.5 GHz at collector currents from 10 mA to 70 mA
- Pb-free (RoHS compliant) package 1)
- Qualified according AEC Q101
- \* Short term description





### ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking	Pin Configuration				Package		
BFG19S	BFG19S	1 = E	2 = B	3 = E	4 = C	ı	-	SOT223

### **Maximum Ratings**

Parameter	Symbol	Value	Unit
Collector-emitter voltage	$V_{\sf CEO}$	15	V
Collector-emitter voltage	$V_{CES}$	20	
Collector-base voltage	$V_{CBO}$	20	
Emitter-base voltage	$V_{EBO}$	3	
Collector current	I <sub>C</sub>	210	mA
Base current	I <sub>B</sub>	21	
Total power dissipation <sup>2)</sup>	P <sub>tot</sub>	1	W
_ <i>T</i> <sub>S</sub> ≤ 75°C			
Junction temperature	$ T_{i} $	150	°C
Ambient temperature	$ T_{A} $	-65 150	
Storage temperature	T <sub>stg</sub>	-65 150	

### **Thermal Resistance**

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>3)</sup>	R <sub>thJS</sub>	≤ 75	K/W

<sup>&</sup>lt;sup>1</sup>Pb-containing package may be available upon special request

 $<sup>{}^2</sup>T_{
m S}$  is measured on the collector lead at the soldering point to the pcb

 $<sup>^3</sup>$ For calculation of  $R_{\text{th,IA}}$  please refer to Application Note Thermal Resistance



# **Electrical Characteristics** at $T_A = 25$ °C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics	,			•	•
Collector-emitter breakdown voltage	V <sub>(BR)CEO</sub>	15	-	-	V
$I_{\rm C}$ = 1 mA, $I_{\rm B}$ = 0	, ,				
Collector-emitter cutoff current	I <sub>CES</sub>	-	-	100	μΑ
$V_{CE} = 20 \text{ V}, V_{BE} = 0$					
Collector-base cutoff current	I <sub>CBO</sub>	-	-	100	nA
$V_{\rm CB} = 10 \text{ V}, I_{\rm E} = 0$					
Emitter-base cutoff current	I <sub>EBO</sub>	-	-	10	μA
$V_{\rm EB} = 2  \text{V},  I_{\rm C} = 0$					
DC current gain-	h <sub>FE</sub>	70	100	140	-
$I_{\rm C}$ = 70 mA, $V_{\rm CE}$ = 8 V, pulse measured					



**Electrical Characteristics** at  $T_A = 25^{\circ}$ C, unless otherwise specified

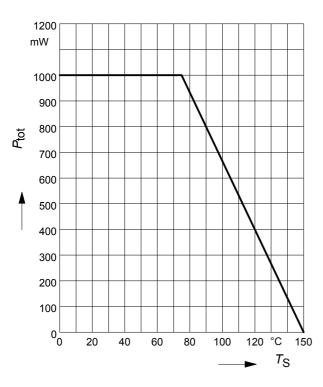
Parameter	Symbol		Unit		
		min.	typ.	max.	
AC Characteristics (verified by random sampling	ng)				
Transition frequency	$f_{T}$	4	5.5	-	GHz
$I_{\rm C}$ = 70 mA, $V_{\rm CE}$ = 8 V, $f$ = 500 MHz					
Collector-base capacitance	C <sub>cb</sub>	-	0.8	1.1	pF
$V_{\text{CB}} = 10 \text{ V}, f = 1 \text{ MHz}, V_{\text{BE}} = 0$ ,					
emitter grounded					
Collector emitter capacitance	C <sub>ce</sub>	-	0.4	-	
$V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$ ,					
base grounded					
Emitter-base capacitance	C <sub>eb</sub>	_	4.1	_	
$V_{\text{EB}} = 0.5 \text{ V}, f = 1 \text{ MHz}, V_{\text{CB}} = 0$ ,					
collector grounded					
Noise figure	F				dB
$I_{\rm C}$ = 20 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$ ,					
f = 900 MHz		-	2	_	
f = 1.8 GHz		-	3	-	
Power gain, maximum available <sup>1)</sup>	G <sub>ma</sub>				
$I_{\rm C}$ = 70 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$ , $Z_{\rm L}$ = $Z_{\rm Lopt}$ ,					
f = 900 MHz		-	14	_	
f = 1.8 GHz		-	8.5	-	
Transducer gain	S <sub>21e</sub>   <sup>2</sup>				dB
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 $\Omega$ ,					
f = 900 MHz		-	11	_	
f = 1.8 GHz		_	5.5	_	
Third order intercept point at output	IP <sub>3</sub>	-	32	_	dBm
$V_{\text{CE}}$ = 8 V, $I_{\text{C}}$ = 70 mA, $f$ = 900 MHz,					
$Z_{\rm S} = Z_{\rm L} = 50\Omega$					

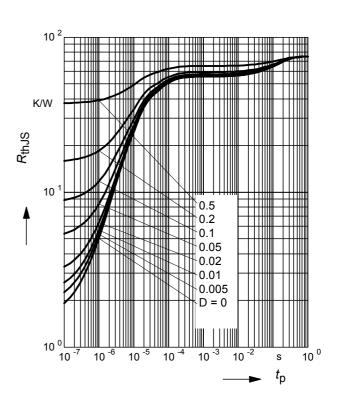
 $<sup>{}^{1}</sup>G_{ma} = |S_{21}/S_{12}| (k-(k^{2}-1)^{1/2})$ 



### Total power dissipation $P_{tot} = f(T_S)$

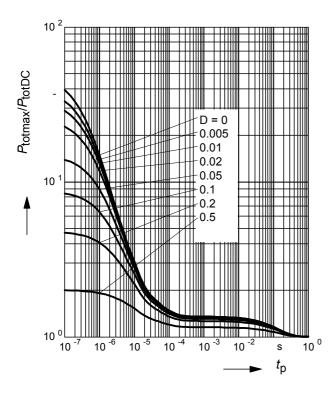
## Permissible Pulse Load $R_{thJS} = f(t_p)$



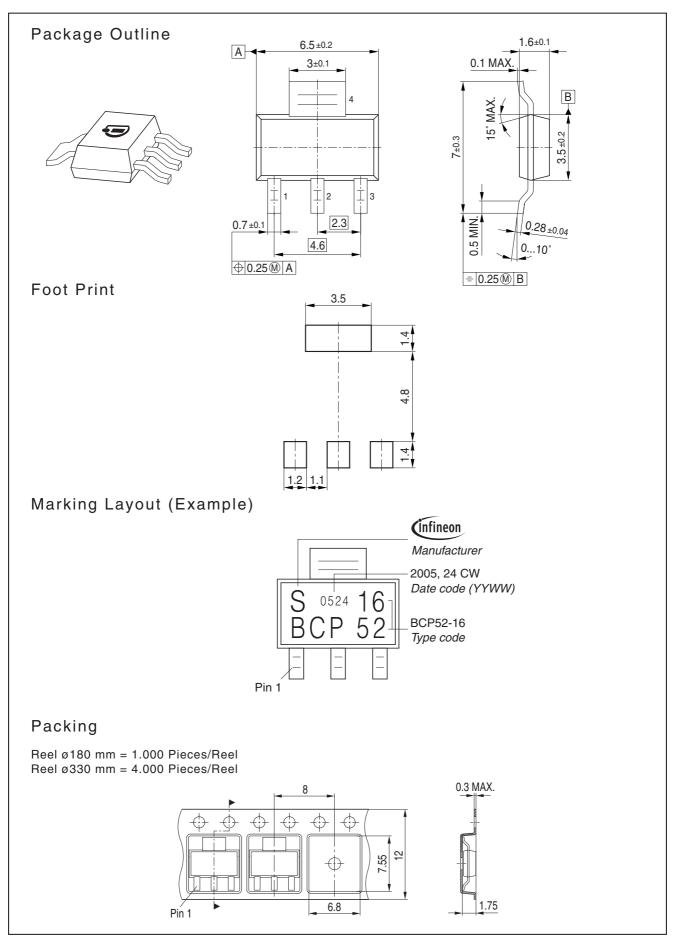


### **Permissible Pulse Load**

$$P_{\text{totmax}}/P_{\text{totDC}} = f(t_{p})$$









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